

MOLDING POWER INDUCTORS HIGH CURRENT INDUCTORS -EPI13067 SERIES

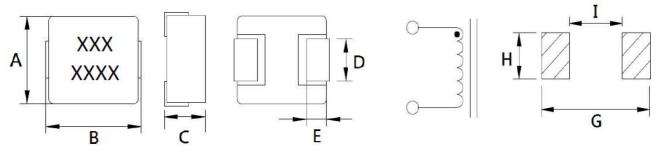


FEATURE

- 1. Shielded construction
- 2. Frequency range up to 5MHz, Low DCR(Ω), Low Buzz Noise
- Applications
- 1. Notebook, server application, High current power supplier

Shape and Dimension

Schematics and Land Patterns(mm)



A=12.90 m/m Max; B=14.00 m/m Max; C=6.70 m/m Max.; D=refer Note.7; E=2.40 m/m Ref.; G=14.00 m/m Ref.; H=5.15 m/m Ref.; H=7.60 m/m Ref.

Specification

P/N	L	RDC	RDC	Isat	Irms
	(µH)	(mΩ) Typical	(mΩ)Max	(A)	(A)
EPI13067-R10N	0.10±30%	0.25	0.50	80.0	60.0
EPI13067-R22M	0.22±20%	0.45	0.70	75.0	53.0
EPI13067-R30M	0.30±20%	0.50	0.80	72.0	48.0
EPI13067-R33M	0.33±20%	0.51	0.80	65.0	46.0
EPI13067-R40M	0.40±20%	0.60	1.00	64.0	44.0
EPI13067-R47M	0.47±20%	0.75	1.20	63.0	41.0
EPI13067-R56M	0.56±20%	0.90	1.40	62.0	37.0
EPI13067-R68M	0.68±20%	1.00	1.60	51.0	35.0
EPI13067-R82M	0.82±20%	1.55	1.90	50.0	33.0
EPI13067-1R0M	1.0±20%	1.85	2.00	49.0	32.0
EPI13067-1R2M	1.2±20%	2.30	2.50	45.0	30.0
EPI13067-1R5M	1.5±20%	2.30	3.00	40.0	25.0
EPI13067-2R2M	2.2±20%	3.50	4.20	33.0	22.0
EPI13067-3R3M	3.3±20%	5.50	6.80	29.0	18.0
EPI13067-4R7M	4.7±20%	9.80	11.2	25.0	13.5
EPI13067-5R6M	5.6±20%	10.5	11.5	21.0	12.0
EPI13067-6R8M	6.8±20%	13.8	14.9	16.5	11.5
EPI13067-8R2M	8.2±20%	15.1	16.6	16.0	10.5
EPI13067-100M	10±20%	17.5	18.5	15.5	10.0



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P/N	L (µH)	RDC (mΩ) Typical	RDC (mΩ)Max	Isat (A)	Irms (A)
EPI13067-150M	15±20%	27.5	32	11.0	7.0
EPI13067-220M	22±20%	35	45	8.0	5.0
EPI13067-330M	33±20%	72	82	7.0	4.5
EPI13067-470M	47±20%	85	90	6.5	4.0
EPI13067-680M	68±20%	160	172	6.0	3.0
EPI13067-101M	100±20%	240	265	4.0	2.5

Note1. Measurement frequency of Inductance value: at 100KHz, 0.25V

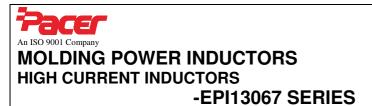
Note2. Measurement ambient temperature of L, DCR and IDC : at 25 $^{\circ}\!\mathbb{C}$

Note3. Isat: DC current at which the inductance drops 20%(typ) from its value without current

Note4. Irms: Average current for 40°C temperature rise from 25°C ambient(typical)

Note5. Inductance tolerance: M: ±20%; N: ±30% Note6. Packaging: Taping; Quantity: 250pcs/reel

Note7. D Dimension range: R10~1R5, D= 4.0 ± 0.5 mm ; 2R2, D= 3.0 ± 0.5 mm ; 3R3~101, D= 4.7 ± 0.3 mm

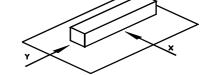




GENERAL CHARACTERISTICS

- 1. Operating temperature range: -55 TO + 125°C (Includes temperature when the coil is heated)
- 2. External appearance: On visual inspection, the coil has no external defects.
- Terminal strength: After soldering. Between copper plate and terminals of coil. Push in two directions of X.Y withstanding at below conditions.

Terminal should not peel off. (refer to figure at right) 5. 0N 60 sec.



- 4. Insulating resistance: Over $100M\Omega$ at 100V D.C. between coil and core.
- 5. Dielectric strength: No dielectric breakdown at 100V D.C. for 1 minute between coil and core.
- 6. Temperature characteristics: Inductance coefficient (0~2,000)x10-6/°C (-25~+80°C).
- 7. Humidity characteristics(Moisture Resistance): Inductance deviation within ±5%, after 96 hours in 90~95% relative humidity at 40 ±2°C and 1 hour drying under normal condition.
- 8. Vibration resistance: Inductance deviation within ±5%, after vibration for 1 hour. In each of three orientations at sweep vibration (10~55~10 Hz) with 1.5mm P-P amplitudes.
- 9. Shock resistance: Inductance deviation within ±5%, after being dropped once with 981m/s2 (100G) shock attitude upon a rubber block method shock testing machine, in three different orientations.
- 10. Resistance to Soldering Heat: 260°C, 10 seconds(See attached recommend reflow)
- 11. Storage environment: Storage condition: Temperature Range: $10^{\circ}\text{C} \sim 35^{\circ}\text{C}$ (Generally: $21^{\circ}\text{C} \sim 31^{\circ}\text{C}$) , Humidity Range: $50\% \sim 80\%$ RH (Generally: $65\% \sim 75\%$); Transportation condition: Temperature Range: $-35^{\circ}\text{C} \sim 85^{\circ}\text{C}$, Humidity Range: $50\% \sim 95\%$ RH
- 12. Use components within 12 months. If 12 months or more have elapsed, check solderability before use.
- 13. Reflow profile recommend:

Lead-free heat endurance test

Lead-free the recommended reflow condition

